

TPS3780EVM-154 Evaluation Module

This user's guide describes the operational use of the TPS3780EVM-154 evaluation module (EVM) as a reference design for engineering demonstration and evaluation of the TPS3780EVM, two-channel voltage detectors with low-power and high-accuracy comparators. Included in this user's guide are setup instructions, a schematic diagram, printed circuit board (PCB) layout drawings, and a bill of materials for the evaluation module. This user's guide also discusses how to modify the TPS3780EVM-154 board to evaluate the TPS3779.

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Introduction www.ti.com

1 Introduction

The Texas Instruments TPS3780EVM-154 helps design engineers evaluate the operation and performance of two TPS3780 ICs with different hysteresis options (TPS3780ADRYR/T and TPS3780BDRYR/T) for possible use in their own circuit application. This particular EVM configuration contains two dual-voltage detectors with low quiescent current and high threshold accuracy in a small μ SON (1.45 mm \times 1 mm) package. This document describes the configuration and set up of the TPS3780EVM-154 EVM board.

2 Setup

This section describes the jumpers and connectors on the EVM as well as how to properly connect, setup, and use the TPS3780EVM-154.

2.1 Input and Output Connector and Jumper Descriptions

2.1.1 TP1 to TP2: VDD

This connector is the input power-supply connection.

2.1.2 TP3: GND

Return connector for the input power supply. This connector is also connected to TP8 and TP13 in the EVM.

2.1.3 TP4 to TP5: SENSE1

This connector is connected to the voltage that is monitored.

2.1.4 TP8: GND

Return connector for the SENSE1 and SENSE2 voltage signal. This connector is also connected to TP3 and TP13 in the EVM.

2.1.5 TP6 to TP7: SENSE2

This connector is connected to a second voltage that will be monitored.

2.1.6 TP11 to TP12: OUT1

This connector is the open-drain output of comparator 1 that pulls up to VPU through a 50-k Ω resistor in the EVM. Connect a voltage meter or oscilloscope probe from TP11 to GND (TP13).

2.1.7 TP13: GND

Return connector for the OUT1 and OUT2 outputs. This connector is also connected to TP3 and TP8 in the EVM.

2.1.8 TP9 to TP10: OUT2

This connector is the open-drain output of comparator 2 that pulls up to VPU through a 50-k Ω resistor in the EVM. Connect a voltage meter or oscilloscope probe from TP9 to GND (TP13).



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2.1.9 J1: VPU

The TPS3780EVM-154 is designed for OUT1 and OUT2 to pull up to either VDD or an external voltage source. Table 1 shows the connections for choosing between the two. If the shorting jumper is removed, an external voltage can be placed on pin 2.

Table 1. Connector JP1 Selections

| Short Pins | Pullup Voltage (VPU) | |
|------------|---------------------------|--|
| 1 and 2 | VDD | |
| OPEN | External voltage on pin 2 | |

2.2 Equipment Setup

This setup is described for evaluating U1 (top IC). This setup can also be used for evaluating U2 (bottom IC).

- Set the first power-supply voltage between 1.5 V to 6.5 V. Turn the power supply off. Connect the
 positive voltage lead from the power supply to TP1 (VDD). Connect the ground lead from the power
 supply to TP3 (GND).
- Set the second power-supply voltage to 0 V. Turn the power supply off. Connect the positive voltage lead from the power supply to TP4 (SENSE1). Connect the ground lead from the power supply to TP8 (GND).
- Set the third power-supply voltage to 0 V. Turn the power supply off. Connect the positive voltage lead from the power supply to TP6 (SENSE2). Connect the ground lead from the power supply to TP8 (GND).
- Place the shorting jumper on JP1 (VPU VDD).
- Turn on all power supplies and vary SENSE1 and SENSE2 as needed to evaluate the TPS3780.

3 Operation

This section provides information about the operation of the TPS3780EVM-154.

3.1 General Operation

The TPS3780EVM-154 is a dual-voltage detector. The device monitors a selected voltage signal (SENSE1 or SENSE2). OUT1 triggers HIGH (VPU) when SENSE1 rises above the VIT+ threshold and triggers LOW (GND) when SENSE1 falls beneath VIT-. OUT2 operates the same way. Table 2 lists the design requirements for general operation.

Table 2. Design Parameters

| Parameter | Design Requirement | Design Result |
|----------------------|--|--|
| VDD | 5 V | 5 V |
| Hysteresis | 10% | 10% |
| Monitored voltage 1 | 3.3 V nominal, $V_{MON(PG)} = 2.9 \text{ V}$, $V_{MON(UV)} = 2.6 \text{ V}$ | $V_{MON(PG)} = 2.908 \text{ V}, V_{MON(UV)} = 2.618 \text{ V}$ |
| Monitored voltage 2 | 3 V nominal, $V_{MON(PG)} = 2.6 \text{ V}$, $V_{MON(UV)} = 2.4 \text{ V}$ | $V_{MON(PG)} = 2.606 \text{ V}, V_{MON(UV)} = 2.371 \text{ V}$ |
| Output logic voltage | 3.3-V CMOS | 3.3-V CMOS |

Setup



Board Layout www.ti.com

4 Board Layout

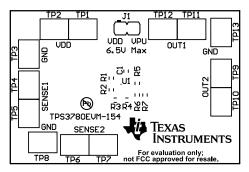


Figure 1. Top Overlay

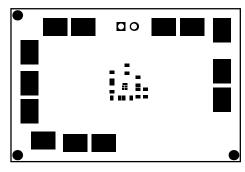


Figure 2. Top Solder Mask

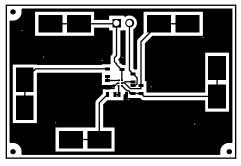


Figure 3. Top Layer

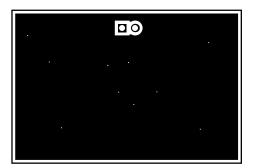


Figure 4. Bottom Layer

5 Schematic

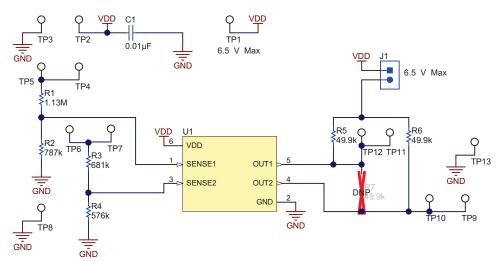


Figure 5. TPS3780EVM-154 Schematic



www.ti.com Bill of Materials

6 Bill of Materials

Table 3. TPS3780EVM-154 Bill of Materials

| Count | RefDes | Value | Description | Size | Part Number | MFR |
|-------|----------|---------|--|----------------------------|--------------------|------------------------|
| 1 | C1 | 0.01uF | CAP, CERM, 0.01 μF, 16 V, +/- 10%, X7R, 0603 | 0603 | GRM188R71C103KA01D | MuRata |
| 1 | J1 | | Header, 2.54 mm, 2x1, Gold, TH | Header, 2.54mm, 2x1, TH | 61300211121 | Wurth Elektronik eiSos |
| 1 | R1 | 1.13Meg | RES, 1.13 M, 1%, 0.1 W, 0603 | 0603 | CRCW06031M13FKEA | Vishay-Dale |
| 1 | R2 | 787k | RES, 787 k, 1%, 0.1 W, 0603 | 0603 | CRCW0603787KFKEA | Vishay-Dale |
| 1 | R3 | 681k | RES, 681 k, 1%, 0.1 W, 0603 | 0603 | CRCW0603681KFKEA | Vishay-Dale |
| 1 | R4 | 576k | RES, 576 k, 1%, 0.1 W, 0603 | 0603 | CRCW0603576KFKEA | Vishay-Dale |
| 2 | R5, R6 | 49.9k | RES, 49.9 k, 1%, 0.1 W, 0603 | 0603 | CRCW060349K9FKEA | Vishay-Dale |
| 1 | SH-J1 | 1x2 | Shunt, 100mil, Gold plated, Black | Shunt | 969102-0000-DA | 3M |
| 13 | TP1-TP13 | SMT | Test Point, Compact, SMT | Testpoint_Keystone_Compact | 5016 | Keystone |
| 1 | U1 | | Low-Power, Dual-Voltage Detector, DRY006A | DRY0006A | TPS3780ADRY | Texas Instruments |
| 0 | R7 | 49.9k | RES, 49.9 k, 1%, 0.1 W, 0603 | 0603 | CRCW060349K9FKEA | Vishay-Dale |

7 Evaluating the TPS3779 Using the TPS3780EVM-154 Board

The TPS3779 and TPS3780 are a family of two-channel voltage detectors with low-power and high-accuracy comparators. The TPS3779 and TPS3780 perform the same functions; however, they use different output stages. The TPS3780 uses an open-drain output while the TPS3779 uses a push-pull output.

7.1 Modifying the TPS3780EVM-154 Board

The TPS3779 uses a push-pull output stage; therefore, pullup resistors are not needed. The following modifications to the TPS3780EVM-154 board can be made to evaluate the TPS3779:

- · Remove resistors R5-R6 or
- Remove J1



Revision History www.ti.com

Revision History

| Cł | Changes from Original (October 2012) to A Revision | | |
|----|---|-----|--|
| | Updated document to reflect the Rev B board | 2 | |
| • | Changed titles of the TP1 to TP2: VDD, TP3: GND, TP4 to TP5: SENSE1, TP8: GND, TP6 to TP7: SENSE2, TP11 TP12: OUT1, TP13: GND, and TP9 to TP10: OUT2 sections | | |
| • | Changed jumper connections to test point connections in TP3: GND, TP8: GND, TP11 to TP12: OUT1, TP13: GND TP9 to TP10: OUT2 sections | | |
| • | Changed J1: VPU section: changed title and changed VCC to VDD in description | 3 | |
| • | Changed VCC to VDD in Table 1 | 3 | |
| • | Deleted sections 2.1.10 through 2.1.18 | 3 | |
| • | Changed Equipment Setup section: changed jumper connections to test point connections and changed VCC to VD | D 3 | |
| • | Changed General Operation section | 3 | |
| • | Changed Board Layout section | | |
| • | Changed Figure 5 | 4 | |
| • | Changed Table 3 | | |
| • | Changed modification steps in <i>Modifying the TPS3780EVM-154 Board</i> section | | |

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

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